

Announcement of NEPCON South China 2017

Fuji Machine Manufacturing Corporation (headquarters: Chiryu, Aichi, Japan; president & CEO: Mr. Nobuyuki Soga) is exhibiting at NEPCON South China 2017 intended for many customers focusing on the smartphone and automotive industries. We will be offering leading IoT technology, FUJI Smart Factory, with Nexim at its core.

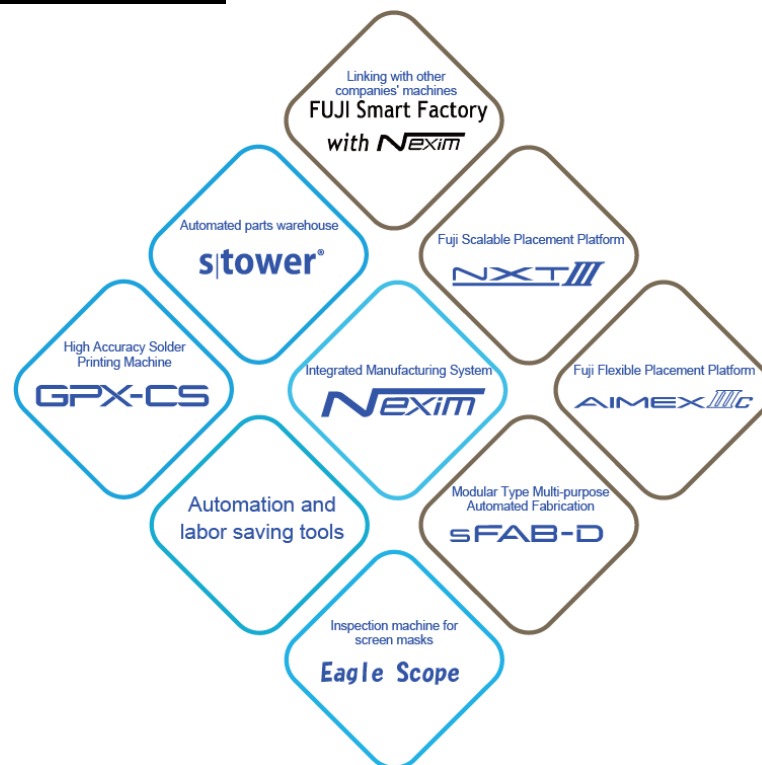
Exhibition name: NEPCON South China 2017

Dates: August 29 (Tuesday) to August 31 (Thursday)

Location: Shenzhen Convention & Exhibition Center



Exhibit and introductions



NXT III: Continuous high speed placement of chip parts using bulk heads (V12D) and high speed dip placement using H24S heads

AIMEX IIIc: From automatic tool exchange on DX heads and support for odd-form parts, to on-machine editing

sFAB-D: High speed automation of insertion parts

Nexim: Engineering, logistics, process and analytics supported in a fully looped system.

s|tower: Automatic part check out, efficient part management and preparation by receiving instructions from Nexim

GPX-CS: Quality improvement through information communication via linking to SPI machines

Solder printing and AOI: Production support as a total line through linkage with other companies' machines